TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

### TC74HC4051AP,TC74HC4051AF,TC74HC4051AFT TC74HC4052AP,TC74HC4052AF,TC74HC4052AFT TC74HC4053AP,TC74HC4053AF,TC74HC4053AFT

TC74HC4051AP/AF/AFT

8-Channel Analog Multiplexer/Demultiplexer

TC74HC4052AP/AF/AFT

Dual 4-Channel Analog Multiplexer/Demultiplexer

TC74HC4053AP/AF/AFT

Triple 2-Channel Analog Multiplexer/Demultiplexer

The TC74HC4051A/4052A/4053A are high speed CMOS ANALOG MULTIPLEXER/DEMULTIPLEXER fabricated with silicon gate C²MOS technology. They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The TC74HC4051A has an 8 channel configuration, the TC74HC4052A has a 4 channel  $\times$  2 configuration and the TC74HC4053A has a 2 channel  $\times$  3 configuration.

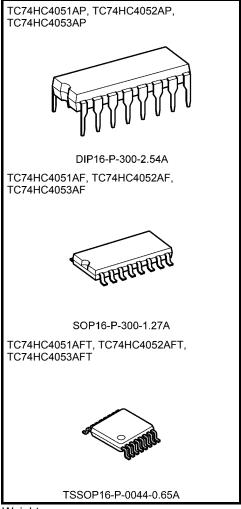
The digital signal to the control terminal turns "ON" the corresponding switch of each channel a large amplitude signal ( $V_{\rm CC}-V_{\rm EE}$ ) can then be switched by the small logical amplitude ( $V_{\rm CC}-G_{\rm ND}$ ) control signal.

For example, in the case of VCC = 5 V, GND = 0 V, VEE = -5 V, signals between -5 V and +5 V can be switched from the logical circuit with a single power supply of 5 V. As the ON-resistance of each switch is low, they can be connected to circuits with low input impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $t_{pd} = 15 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_a = 25^{\circ}C$
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Low ON resistance:  $R_{ON} = 50 \Omega$  (typ.) at  $V_{CC} V_{EE} = 9 V$
- High noise immunity: THD = 0.02% (typ.) at  $V_{CC} V_{EE} = 9 \text{ V}$
- Pin and function compatible with 4051/4052/4053B

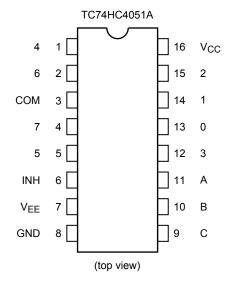


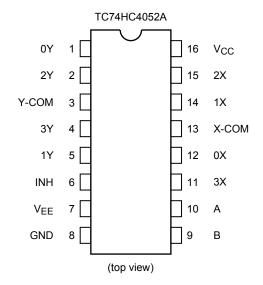
Weight

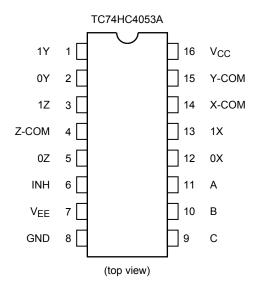
DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.) TSSOP16-P-0044-0.65A : 0.06 g (typ.)



### **Pin Assignment**



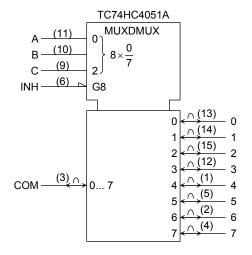


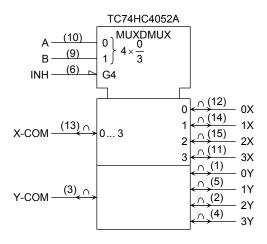


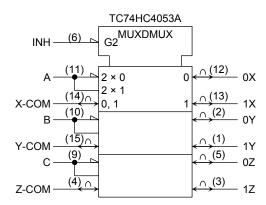
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### **IEC Logic Symbol**







### **Truth Table**

Control Inputs				"ON" Channel				
Inhibit	C*	В	Α	HC4051A	HC4053A			
L	L	L	L	0	0X, 0Y	0X, 0Y, 0Z		
L	L	L	Н	1	1X, 1Y	1X, 0Y, 0Z		
L	L	Н	L	2	2X, 2Y	0X, 1Y, 0Z		
L	L	Н	Н	3	3X, 3Y	1X, 1Y, 0Z		
L	Н	L	L	4	_	0X, 0Y, 1Z		
L	Н	L	Н	5	_	1X, 0Y, 1Z		
L	Н	Н	L	6	_	0X, 1Y, 1Z		
L	Н	Н	Н	7	_	1X, 1Y, 1Z		
Н	Х	Х	Х	None	None	None		

X: Don't care

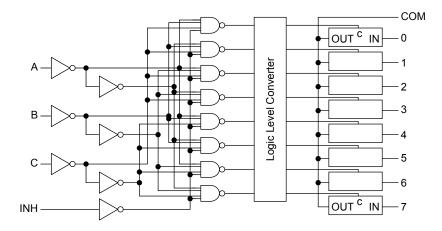
\*: Except HC4052A

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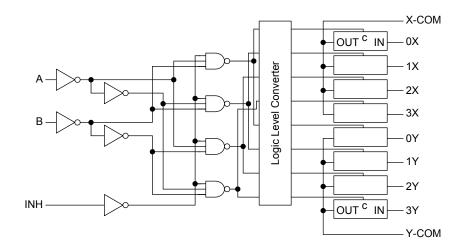


## **System Diagram**

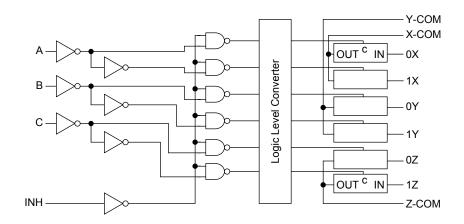
### TC74HC4051A



#### TC74HC4052A



#### TC74HC4053A





#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
Supply voltage range	V <sub>CC</sub> -V <sub>EE</sub>	-0.5 to 13	V
Control input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Switch I/O voltage	V <sub>I/O</sub>	V <sub>EE</sub> – 0.5 to V <sub>CC</sub> + 0.5	V
Control input diode current	I <sub>ICK</sub>	±20	mA
I/O diode current	lok	±20	mA
Switch through current	ΙΤ	±25	mA
DC V <sub>CC</sub> or ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP, TSSOP)	mW
Storage temperature	T <sub>stg</sub>	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	2 to 6	V
Supply voltage range	V <sub>EE</sub>	−6 to 0	V
Supply voltage range	V <sub>CC</sub> -V <sub>EE</sub>	2 to 12	V
Control input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Switch I/O voltage	V <sub>I/O</sub>	V <sub>EE</sub> to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Control input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused control inputs must be tied to either VCC or GND.



### **Electrical Characteristics**

### **DC Characteristics**

Characteristics	Symbol	Test Condition				Γa = 25°(	3	Ta = -40 to 85°C		Unit
	- <b>,</b>		V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
				2.0	1.50	_	_	1.50	_	V
High-level control input voltage	$V_{IHC}$	_		4.5	3.15	_	_	3.15	_	
mp at ventage				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level control input voltage	$V_{ILC}$	_		4.5	_	_	1.35	_	1.35	V
. 0				6.0		_	1.80	—	1.80	
		$V_{IN} = V_{ILC}$ or $V_{IHC}$	GND	4.5		85	180	_	225	
		$V_{I/O} = V_{CC}$ to $V_{EE}$	-4.5	4.5	_	55	120	_	150	
	R <sub>ON</sub>	$I_{I/O} \leq 2 \ mA$	-6.0	6.0		50	100	—	125	
ON resistance		$V_{IN} = V_{ILC}$ or $V_{IHC}$ $V_{I/O} = V_{CC}$ or $V_{EE}$	GND	2.0	_	150	_	_	_	Ω
			GND	4.5	_	70	150	_	190	
		I <sub>I/O</sub> ≤ 2 mA	-4.5	4.5	_	50	100	_	125	
		1//0 = 2 11/4	-6.0	6.0	_	45	80	_	100	
Difference of ON	ΔR <sub>ON</sub>	$V_{IN} = V_{ILC}$ or $V_{IHC}$	GND	4.5	_	10	30	_	35	
resistance between		$V_{I/O} = V_{CC}$ to $V_{EE}$	-4.5	4.5	_	5	12	_	15	Ω
switches		$I_{I/O} \leq 2 \ mA$	-6.0	6.0		5	10	—	12	
Input/output leakage		$V_{OS} = V_{CC}$ or GND	GND	6.0			±60		±600	
current	l <sub>OFF</sub>	$V_{IS} = GND \text{ or } V_{CC}$	-6.0			-   -	±100		±1000	nA
(switch off)		$V_{IN} = V_{ILC}$ or $V_{IHC}$	0.0	0.0			±100		1000	
Switch input leakage current	lız	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0	_	_	±60	_	±600	
(switch on)		V <sub>IN</sub> = V <sub>ILC</sub> or V <sub>IHC</sub>	-6.0	6.0	_	_	±100	_	±1000	nA
Control input current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0			±0.1	_	±1.0	μА
,	чN	AIM - ACC OL GIAD	GND	6.0			4.0		±1.0 40.0	μΑ
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND	-6.0	6.0		_	8.0	_	80.0	μА
			-6.0	0.0	_	_	8.0	_	80.0	



### AC Characteristics ( $C_L = 50 \text{ pF}$ , input: $t_r = t_f = 6 \text{ ns}$ , GND = 0 V)

Characteristics	Symbol		Test Condition			-	Га = 25°(		Ta = -40 to 85°C		Unit
				V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
				GND	2.0	_	25	60	_	75	
Phase difference between input and output	<b>10</b> =	All turnes		GND	4.5	_	6	12	_	15	20
	ΦΙ/Ο	All types		GND	6.0	_	5	10	_	13	ns
				-4.5	4.5		4	_	_	_	
				GND	2.0	_	64	225	_	280	
		4051	(Note 1)	GND	4.5	_	18	45	_	56	
		4031	(Note 1)	GND	6.0	_	15	38	_	48	
				-4.5	4.5		18		_	_	
				GND	2.0	_	64	225	_	280	
Output enable time	$t_{pZL}$	4052	(Note 1)	GND	4.5	_	18	45	_	56	ns
Output enable time	$t_{pZH}$	4032	(Note 1)	GND	6.0	_	15	38	_	48	113
				-4.5	4.5		18		_	_	
				GND	2.0	_	50	225	_	280	
		4053	(Note 1)	GND	4.5	_	14	45	_	56	
		4033		GND	6.0	_	12	38	_	48	
				-4.5	4.5		14	_	_	_	
	40			GND	2.0	_	100	250	_	315	
		4051	(Note 1)	GND	4.5	_	33	50	_	63	ns
				GND	6.0	_	28	43	_	54	
				-4.5	4.5		29		_	_	
				GND	2.0	_	100	250	_	315	
Output disable time	t <sub>pLZ</sub>	4052	(Note 1)	GND	4.5	_	33	50	_	63	
Output disable time	$t_{pHZ}$			GND	6.0	_	28	43	_	54	
				-4.5	4.5		29		_	_	
		4053	(Note 1)	GND	2.0		95	225	_	280	
				GND	4.5	_	30	45	_	56	
		1000	(11010-1)	GND	6.0	_	26	38	_	48	
				-4.5	4.5		26	_	_	_	
Control input capacitance	C <sub>IN</sub>	All types		_	_	_	5	10	_	10	pF
		4051				_	36	70	_	70	
COMMON terminal capacitance	$C_IS$	4052		-5.0	5.0	_	19	40	_	40	pF
		4053				_	11	20	_	20	
		4051				_	7	15	_	15	
SWITCH terminal capacitance	Cos	4052		-5.0	5.0	_	7	15	_	15	pF
		4053				_	7	15	_	15	
		4051				_	0.95	2	_	2	
Feedthrough capacitance	C <sub>IOS</sub>	4052		-5.0	5.0	_	0.85	2	_	2	pF
- S.P		4053				_	0.75	2	_	2	
		4051				_	70	_	_	_	
Power dissipation capacitance	$C_{PD}$	4052	(Note 2)	GND	5.0	_	71	_	_	_	pF
Sapaonario		4053				_	67	_	_	_	

Note 1:  $R_L = 1 k\Omega$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance of IC which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 



### Analog Switch Characteristics (GND = 0 V, Ta = 25°C) (Note 1)

		Test (						
Characteristics	Symbol				V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Тур.	Unit
Sine wave distortion (T.H.D)		$R_L=10~k\Omega,$ $C_L=50~pF$ $f_{IN}=1~kHz$ Adjust $f_{IN}$ voltage to obtain	V <sub>IN</sub> = V <sub>IN</sub> = V <sub>IN</sub> = AII 4051 4052 4053	4.0 V <sub>p-p</sub> 8.0 V <sub>p-p</sub> 11.0 V <sub>p-p</sub> (Note 2) (Note 3)	-2.25 -4.5 -6.0	2.25 4.5 6.0 2.25	0.025 0.020 0.018 120 45 70 95	%
Frequency response (switch on)	f <sub>max</sub>	odBm at $V_{OS}$ Increase $f_{IN}$ frequency until dB meter reads $-3$ dB $R_L = 50 \ \Omega$ , $C_L = 10 \ pF$ $f_{IN}$ = 1 MHz, sine wave	All 4051 4052 4053 All 4051 4052 4053	(Note 2) (Note 3) (Note 2) (Note 3)	-4.5	4.5	190 70 110 150 200 85 140 190	MHz
Feed through attenuation (switch off)  Crosstalk		$V_{IN}$ is centered at $(V_{CC} - V_E)$ Adjust input for 0dBm $R_L = 600 \ \Omega, \ C_L = 50 \ pF$ $f_{IN} = 1 \ MHz$ , sine wave $R_L = 600 \ \Omega, \ C_L = 50 \ pF$	E)/2		-2.25 -4.5 -6.0	2.25 4.5 6.0 2.25	-50 -50 -50	dB
(control input to signal output)  Crosstalk (between any switches)		$f_{IN}$ = 1 MHz, square wave Adjust V <sub>IN</sub> to obtain 0dBm at $R_L$ = 600 $\Omega$ , $C_L$ = 50 pF $f_{IN}$ = 1 MHz, sine wave	-4.5 -6.0 -2.25 -4.5 -6.0	4.5 6.0 2.25 4.5 6.0	140 200 -50 -50 -50	mV dB		

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Note 1: These characteristics are determined by design of devices.

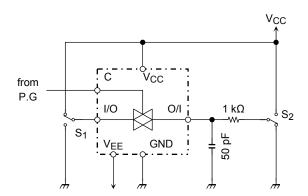
Note 2: Input COMMON terminal, and measured at SWITCH terminal.

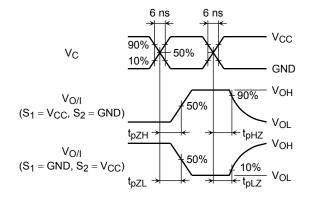
Note 3: Input SWITCH terminal, and measured at COMMON terminal.



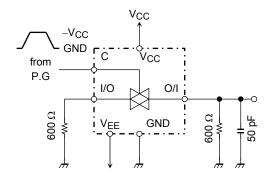
### **Switching Characteristics Test Circuits**

# $1. \quad t_{pLZ},\, t_{pHZ},\, t_{pZL},\, t_{pZH}$

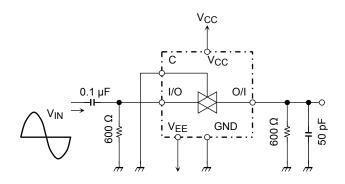




### 2. Cross Talk (control input-switch output) $f_{IN} = 1$ MHz duty = 50% $t_r = t_f = 6$ ns

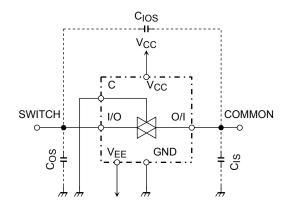


### 3. Feedthrough Attenuation

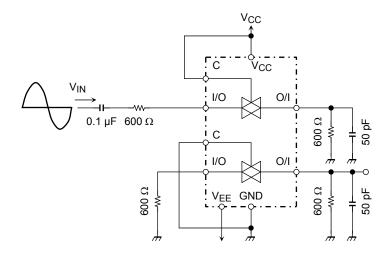


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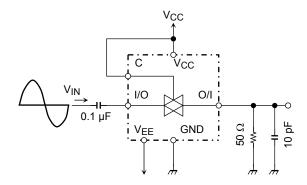
#### 4. CIOS, CIS, COS



### 5. Cross Talk (between any two switches)

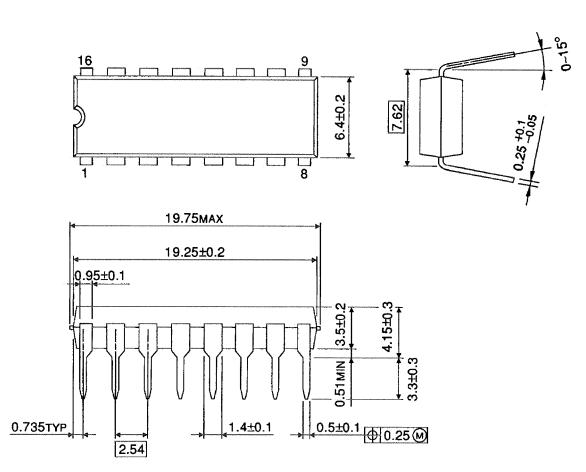


### 6. Frequency Response (switch on)



## **Package Dimensions**

DIP16-P-300-2.54A Unit: mm

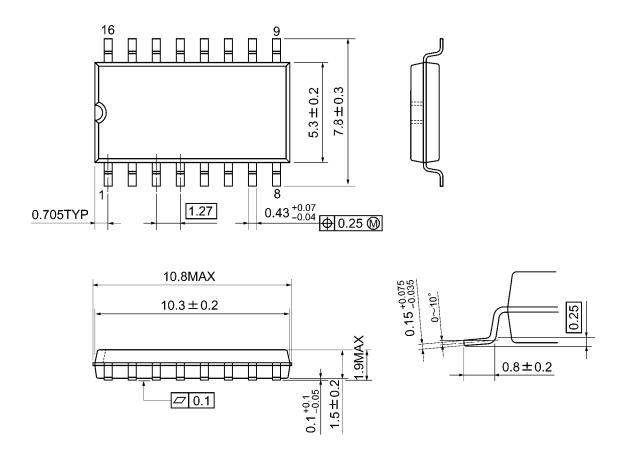


Weight: 1.00 g (typ.)



## **Package Dimensions**

SOP16-P-300-1.27A Unit: mm

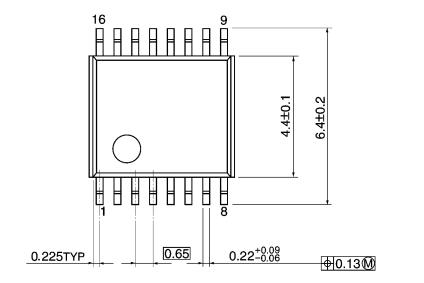


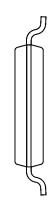
Weight: 0.18 g (typ.)

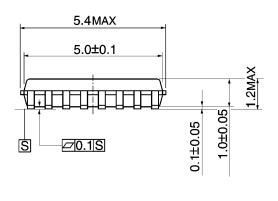
## **Package Dimensions**

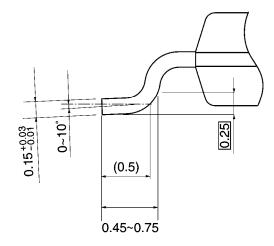
TSSOP16-P-0044-0.65A

Unit: mm









Weight: 0.06 g (typ.)



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